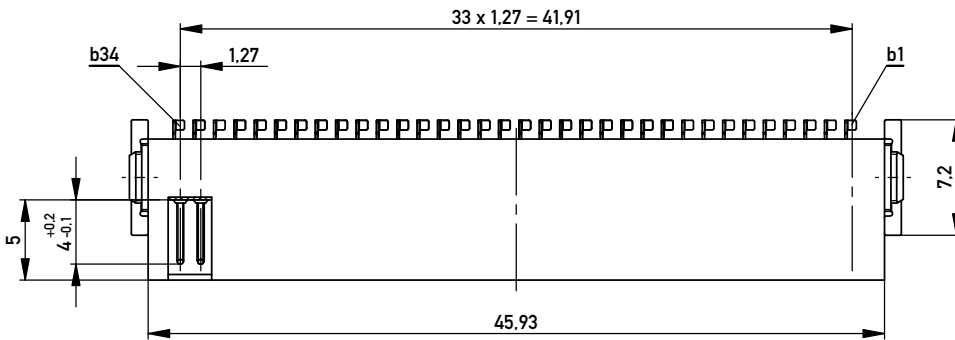
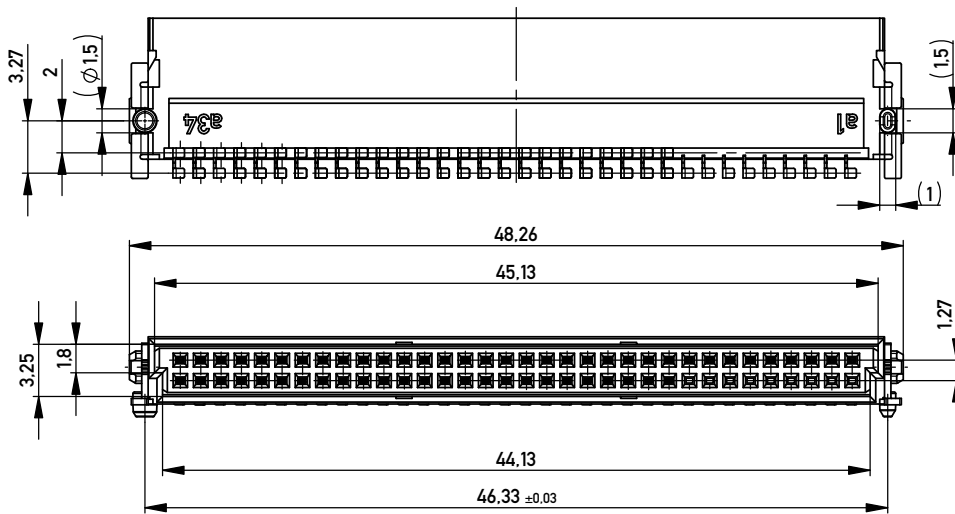
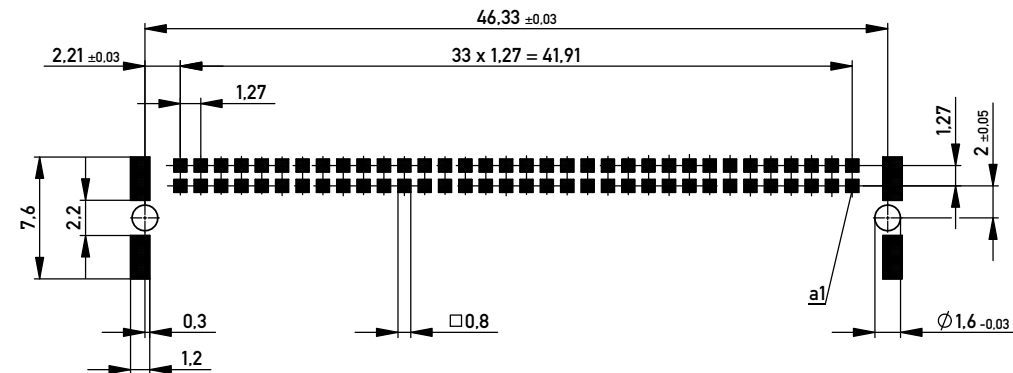




Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT

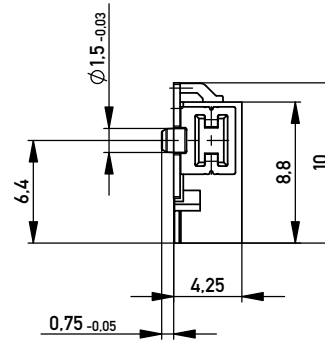


Anforderungsstufe 1
Performance Level 1

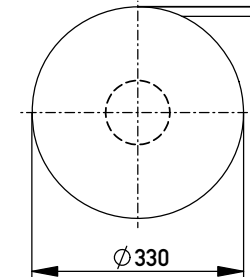
Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

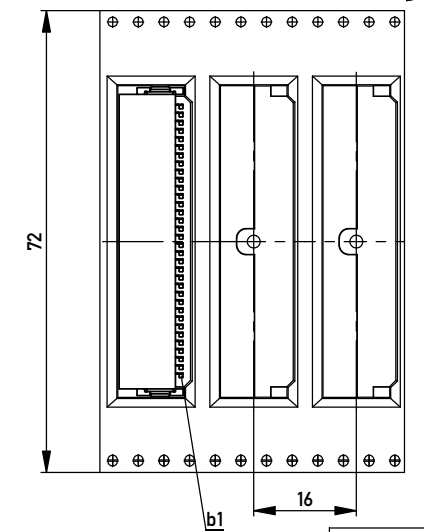
Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm



Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 560 Stück
Packaging unit: 560 pcs



Abspulrichtung - Reel off Direction



BA7-03 - Standard Bauhöhe

type7-03 - Standard Assembly Height

Information:		Tolerances		Scale	3:1
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		www.ERNI.com		Messerl. SMC-B 68-SMD-BA7-03 Male SMC-B 68-SMD-type7-03	
e		25.06.2015		154766	
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				Class	
				SMCB	

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